

**PATENT**

Docket No.:JCLA10375-D

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of :  
Applicant : YU-LUNG YU et al.  
Filed : Herewith  
For : WAFER LEVEL TESTING AND BUMPING PROCESS

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**PRELIMINARY AMENDMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

Prior to the examination on merits, please amend the above-identified application as shown in the attached sheets. No new matter has added through the amendment. Entry of the amendment is requested.